

# APPROVAL SHEET

# MULTILAYER CERAMIC CAPACITORS

3-Terminal Capacitor Series (FT)

Feed Through Type

0402 & 0805 Size (4V to 100V)

X7R & X5R Dielectrics

Halogen Free & RoHS Compliance

\*Contents in this sheet are subject to change without prior notice.



#### **Multilayer Ceramic Capacitors**

#### Approval Sheet

## 1. DESCRIPTION

This product specification is applied to 3-terminal Capacitor for FT Series used for General Electronic equipment. WTC capacitor Feed Through type are developed to offer designers the opportunity to lower placement costs increase assembly line output through lower component count per board.

# 2. FEATURES

- a. High density mounting due to mounting space saving.
- b. Mounting cost saving.
- c. Increased throughput.

## 3. APPLICATIONS

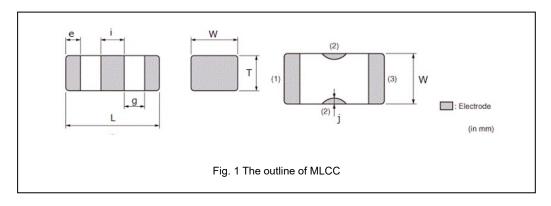
- a. For use as a bypass for digital and analog signal line noise
- b. Computer motherboards and peripherals.
- c. The other common electronic circuits.

## 4. HOW TO ORDER

I	<u>C</u>	<u>160</u>	<u>K</u>	<u>474</u>	<u>B</u>	<u>21</u>	<u>FT</u>
ation Packaging	<u>Termination</u>	Rated voltage	<u>Tolerance</u>	Capacitance	<u>Dielectric</u>	Size	<u>Series</u>
Sn <b>T</b> =7" reeled	<b>C</b> =Cu/Ni/Sn	Two significant digits followed by no. of zeros. And R is in place of decimal point. eg.:  2R5=2.5 VDC  4R0=4 VDC  100=10 VDC  160=16 VDC  250=25 VDC  500=50 VDC  101=100 VDC	侵害公司	digits followed by no. of zeros. And R is in place of decimal point. eg.: 0R5=0.5pF 1R0=1.0pF 105=10x10 <sup>5</sup> =1000nF		<b>15</b> =0402 (1005) <b>21</b> =0805 (2012)	FT= Feed Through Capacitor
â	<u>Termin</u> <b>C</b> =Cu/Ni/	Rated voltage Two significant digits followed by no. of zeros. And R is in place of decimal point. eg.: 2R5=2.5 VDC 4R0=4 VDC 100=10 VDC 160=16 VDC 250=25 VDC 500=50 VDC	Tolerance K=±10% M=±20%	Capacitance Two significant digits followed by no. of zeros. And R is in place of decimal point.  eg.; 0R5=0.5pF 1R0=1.0pF 105=10x10 <sup>5</sup> =1000nF	<u>Dielectric</u> B=X7R	<u>Size</u> <b>15</b> =0402 (1005)	Series  FT= Feed Through

# **5. EXTERNAL DIMENSIONS**



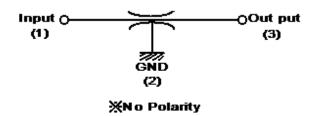


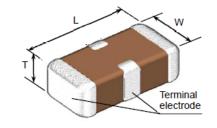
Brand	L (mm)	W (mm)	T (mm)/Sym	ibol	e (mm)	g (mm)	i (mm)	j(mm)
0402	1.00±0.10	0.50±0.20	0.4±0.10	W	0.17±0.10	0.10 min	0.35±0.10	0.15±0.10
0805	2.00±0.20	1.25±0.10	0.85±0.10	Т	0.30±0.20	0.40±0.20	0.60±0.20	0.25±0.20

Reflow soldering process only.

# 6. Rated value

a)Equivalent Circuit





				TIDE V			
WTC PART NO.	Nominal Capacitance	Capacitance Tolerance	DC Rated Voltage	Rated Current (mA)	DC Resistance	Insulation Resistance	Operating Temp. Range
FT15X435M4R0	4.3 uF	±20%	DC4 V	2A(DC)	0.03 Ω max	25M $\Omega$ min	-55 to 85°C
FT21B103M101	10 nF	±20%	DC100 V	2A(DC)	0.03Ωmax	1000M $\Omega$ min	-55 to 125°C
FT21B103M500	10 nF	±20%	DC50 V	2A(DC)	0.03 Ω max	1000M $\Omega$ min	-55 to 125°C
FT21B223M500	22 nF	±20%	DC50 V	2A(DC)	0.03Ωmax	1000M $\Omega$ min	-55 to 125°C
FT21B473M500	47 nF	±20%	DC50 V	2A(DC)	0.03 Ω max	1000M $\Omega$ min	-55 to 125°C
FT21B104M250	0.1 uF	±20%	DC25 V	2A(DC)	0.03Ωmax	1000M $\Omega$ min	-55 to 125°C
FT21B224M160	0.22 uF	±20%	DC16 V	2A(DC)	0.03 Ω max	1000M $\Omega$ min	-55 to 125°C
FT21B474K160	0.47 uF	±10%	DC16 V	2A(DC)	0.03 Ω max	1000M $\Omega$ min	-55 to 125°C
FT21B474M160	0.47 uF	±20%	DC16 V	2A(DC)	0.03 Ω max	1000M $\Omega$ min	-55 to 125°C
FT21B105M160	1 uF	±20%	DC16 V	4A(DC)	0.02Ωmax	500M $\Omega$ min	-55 to 125°C

<sup>\*</sup> Measured at the condition of 30~70% related humidity.

X7R/X6S/X5R/X7S: Please refer to page 5 "Reliability test conditions and requirements" for detail.

<sup>\*\*</sup> Preconditioning for Class II MLCC: Perform a heat treatment at 150±10°C for 1 hour and then leave in ambient condition for 48±2 hours before measurement.

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# 7. GENERAL ELECTRICAL DATA

No	Item	Specification	Test Method
1	Capacitor(Cap.)	Shown in Rated value.	Frequency : 1.0±0.1kHz
			Voltage : 1±0.2V(rms)
2	Insulation Resistance(I.R.)	Shown in Rated value.	Voltage : Rated Voltage
	, ,		Time : 2 minutes max.
3	DC Resistance	As for Direct Current spec of each product, please	Measured with 100mA max.
		refer to item 6: Rated value.	
		Measuring current shall be 100mA max	
		Rdc I	
4	Withstanding Voltage	Products shall not be damaged.	Test Voltage : Rated Voltage x 300%
			Time: 1 to 5 s
			Charge Current : 50 mA max.
5	Operating Temperature	Shown in Rated value.	Includes self-heating
6	Storage Temperature	5 to 40°C at 20 to 70%RH	

<sup>\*</sup> Measured at 30~70% related humidity.

X7R: Apply 1.0±0.2Vrms, 1.0kHz±10%, at the conditions of 25°C ambient temperature.

X5R: Apply 1.0±0.2Vrms, 1.0kHz±10%, at the conditions of 25°C ambient temperature.

# **8. CAPACITANCE RANGE**

	SIZE Inch (mm)	FT21 0805(2012)					FT15 0402(1005)
	DIELECTRIC				X5R		
RA	TED VOLTAGE (VDC)	10	16	25	50	100	4
	10nF (103)	Т		Т	T	T	
	22nF (223)	Т	Na.	CL T	COLE TO	5	
9	47nF (473)	Т	T-5/1/7	Z'nology	T IIII		
itar	0.10µF (104)	Т	T	MOLOTY CODD	DRATION.		
Capacitance	0.22μF (224)	Т	Т	TOLOGI CONF	Ollin		
Ca	0.47μF (474)	Т	Т				
	1μF (105)	Т	Т				
	4.3μF (435)						W

<sup>1.</sup> The letter in cell is expressed the symbol of product thickness; the capacitance tolerance is "M" only (±20%).

## 9. PACKAGING DIMENSION AND QUANTITY

SIZE Inch (mm)	Thickness/Symb (mm)	ool	Packing	Packing Unit
0402	0.40±0.10	W	180mm Reel PAPER	10000 pcs./Reel
0805	0.85±0.10	Т	180mm Reel PAPER	4000 pcs./Reel

Unit: pieces

<sup>\*\*</sup> Preconditioning for Class II MLCC: Perform a heat treatment at 150±10°C for 1 hour, then leave in ambient condition for 48±2 hours before measurement.

<sup>2.</sup> For more information about products with special capacitance or other data, please contact WTC local representative.

40 DELIABILITY TEST	CONDITIONS AND REQUIREMENTS
IV. KELIADILII I 1ESI	CONDITIONS AND REQUIREMENTS

No.	Item	Test Condition	Requ	uirements	
1.	Appearance and	Visual Inspection and measured with Slide Calipers.	ction and measured with Slide Calipers.  * No remarkable defect.  * Dimensions to conform to individual specification		
	Dimensions				
2.	Capacitance	Frequency : 1.0±0.1kHz			
3.	Solder ability	Test temp.: Room Temperature.  * Solder temperature: 240±3°C  * Immersion time: 3±1 sec.	90% min. coverage of all metal	ized area.	
4.	Resistance to Soldering Heat	* Solder temperature: 270±5°C  * Dipping time: 10±1 sec  * Preheating: 150±10°C, 60 to 90s before immerses the capacitor in a eutectic solder.  *Before initial measurement (Class II only): To apply de-aging at 150°C for 1hr then set for 48±4 hrs at room temp.  *Cap. /I.R. Measurement to be made after de-aging at 150°C	Meet table 1.  Table 1  Appearance Cap. Change I.R. DC Resistance * 25% max. leaching on each e	No damaged Within±7.5% Meet the initial rated value. 0.05Ω max	
5.	Bending Test	for 1hr then set for 48±4 hrs at room temp.  It shall be soldered on the glass-epoxy substrate (100×40×1.0mm).  Table 2 Deflection : 2 mm  Keeping Time : 30 s  Pressure jig  Product  It shall be soldered on the glass-epoxy substrate (100×40×0.8mm)  Table 2 Deflection : 1 mm  Keeping Time : 5 s  Pressure jig  Pressure jig  Pressure jig  Pressure jig  Pressure jig	* 25% max. leaching on each edge.  Meet table2.  Table2  Appearance No damaged Cap. Change Within±7.5%  DC Resistance 0.05Ω max		
	Adhesive Strength of Termination	* Pressurizing force : 5N (≤0603) and 9.8N (>0603) * Test time: FT21: 30±1 sec. FT15: 5±1 sec.	* No remarkable damage or removal of the terminations.		
7.	Vibration Resistance	* Vibration frequency: 10~55 Hz/min.  * Total amplitude: 1.5mm  * Test time: 6 hrs. (Two hrs each in three mutually perpendicular directions.)  *Before initial measurement (Class II only): To apply de-aging at 150°C for 1hr then set for 48±4 hrs at room temp.  *Cap. Measurement to be made after de-aging at 150°C for 1hr then set for 48±4 hrs at room temp.	Meet Table 3.  Table3  Appearance Capacitance DC Resistance	No damaged  Meet the initial rated value  0.05Ω max	

 $<sup>^{\</sup>star}$  "Room condition" Temperature: 15 to 35°C, Relative humidity: 25 to 75%, Atmospheric pressure: 86 to 106kPa.

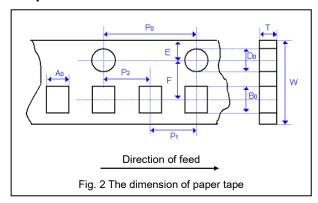
## **Multilayer Ceramic Capacitors**

No.	Item		Test Condition		Req	uirements
8.	Temperature	Conduct	the 10 cycles according to the temp	peratures and time	Meet table 4.	
	Cycling	l			Table 4	
		Step	Temp. (°C)	Time (min.)	Appearance	No damaged
		1	Min. operating temp. +0/-3	30±3	Cap. Change	FT21B: Within±7.5%
		2	Room temp.	2~3		FT15X: Within±12.5%
		3	Max. operating temp. +3/-0	30±3	I.R.	Meet the initial rated value.
		4_	Room temp.	2~3	DC Resistance	0.05Ω max
		*Before in	nitial measurement (Class II only): ٦	To apply de-aging		
		at 150°C	for 1hr then set for 48±4 hrs at room	m temp.		
		* Cap. / I.	R. Measurement to be made after	de-aging at 150°C		
		for 1hr th	en set for 48±4 hrs at room temp.			
		Total of 1	0 cycles			
9.	Humidity	* Test ten	np.: 40±2°C		Then measured after exposure	e in the room condition for 48±4 hours.
	(Damp Heat)	* Humidit	y: 90~95% RH		If it's doubt, the measuring has	s to be done after 1 hours curing
	Steady State	* Test tim	e: 500+24/-0hrs.		at 150+0 / -10°C and 48±4 hou	urs storage.
		*Before in	nitial measurement (Class II only): ٦	Го apply de-aging	Meet Table5.	
		at 150°C	for 1hr then set for 48±4 hrs at room	m temp.	<u>Table5</u>	
		* Cap. / I.	R. Measurement to be made after	de-aging at 150°C	Appearance	No damaged
		for 1hr th	en set for 48±4 hrs at room temp.		Cap. Change	Within±12.5%
			- 51	7月 1	J.R,	FT21B: 1GΩ or RxC≧10
			大道!		3,194	Ω-F whichever is smaller.
			1K WE	内附份。	751	FT15X: 5MΩ min.
			**X		DC Resistance	0.05Ω max
10.	High	Temperat	ture : Maximum Operating Tempera	ture ± 2 °C	A = 50	
	Temperature	Test Volta	age:			
	Load	FT21B: F	Rated Voltage x 200%			
	(Endurance)	FT15_: R	ated Voltage x 100%**	EVE SYSTEM ALI	IANCE	
		Charge C	Current : 50 mA max.	LVE SYSTEM ALI	S S	
		Time : 10	00+48 / -0 hours		Then measured after exposure	e in the room condition for 48±4 hours.
		* Cap. / I.	R. Measurement to be made after	de-aging at 150°C	If it's doubt, the measuring has	to be done after 1 hours curing
		for 1hr th	en set for 48±4 hrs at room temp.		at 150+0 / -10°C and 48±4 hou	urs storage.
			1/1/00 80	hnologi	Meet Table6.	
		** De-ratii	ng conditions:	MOIOBA	Table6	
		120		III POR	Appearance	No damaged
		(%) 100 100		Product for 125°C	Cap. Change	Within±12.5%
	Product for 105°C		I.R.	FT21B: 1GΩ or RxC≧10		
				Ω-F whichever is smaller.		
				FT15X: 5MΩ min.		
		Satio [Operating			DC Resistance	0.05Ω max
		Rat		#		
		0	0 25 50 75 100 125  Temperature at Product (°C)	150		
		I				

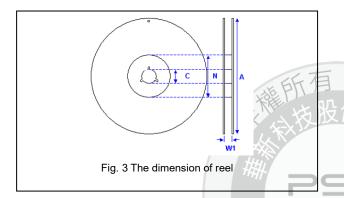
<sup>\* &</sup>quot;Room condition" Temperature: 15 to 35°C, Relative humidity: 25 to 75%, Atmospheric pressure: 86 to 106kPa.

## **APPENDIXES**

## **■ Tape & reel dimensions**



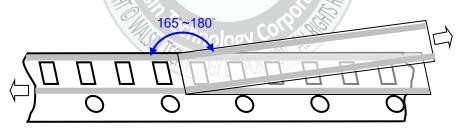
SIZE	FT15	FT21
Inch (mm)	0402 (1005)	0805 (2012)
Thickness	W	T
<b>A</b> <sub>0</sub>	0.70 +/-0.20	1.50 +/-0.20
B <sub>0</sub>	1.20 +/-0.20	2.30 +/-0.20
Т	≦0.80	≦1.20
K <sub>0</sub>	-	-
W	8.00 +/-0.30	8.00 +/-0.30
P <sub>0</sub>	4.00 +/-0.10	4.00 +/-0.10
10xP₀	40.00 +/-0.10	40.00 +/-0.20
<b>P</b> <sub>1</sub>	2.00 +/-0.05	4.00 +/-0.10
P <sub>2</sub>	2.00 +/-0.05	2.00 +/-0.05
D <sub>0</sub>	1.50 +0.10/-0	1.50 +0.1/-0
D <sub>1</sub>	-	-
E	1.75 +/-0.10	1.75 +/-0.10
F	3.50 +/-0.05	3.50 +/-0.05



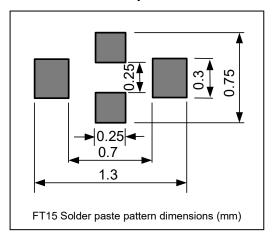
¥ -/					
Reel size	7"				
C	13.0±0.5				
$\bigvee W_1$	10.0±1.5				
1\\ A	178.0±2.0				
N	60.0+1.0/-0				

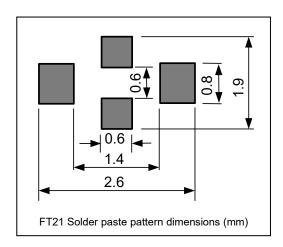
## **■** Peeling force (EIA-481)

Peel-off force should be in the range of 10 grams to 100 grams at a peel-off speed of 300±10 mm/min.



# **■** Guideline of solder paste



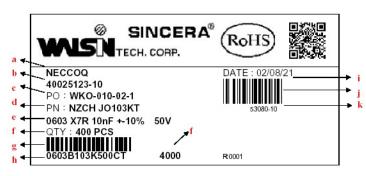


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ASC\_Feed\_Through\_FT

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#### **■** Example of customer label

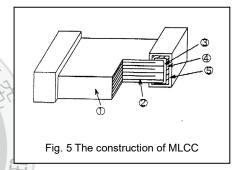


<sup>\*</sup>Customized label is available upon request

- a. Customer name
- b. WTC order series and item number
- c. Customer P/O
- d. Customer P/N
- e. Description of product
- f. Quantity
- g. Bar code including quantity & WTC P/N or customer
- h. WTC P/N
- i. Shipping date
- j. Order bar code including series and item numbers
- k. Serial number of label

#### Constructions

No.	Na	me	X7R, X5R
1	Ceramic	material	BaTiO₃ based
2	Inner electrode		Ni 技力為《
3		Inner layer	Cu
4	Termination	Middle layer	W Ni Ni
(5)		Outer layer	Sn Sn Passive system all tance



#### ■ Storage and handling conditions

- (1) To store products at 5 to 40°C ambient temperature and 20 to 70%. related humidity conditions; MSL Level 1.
- (2) The product is recommended to be used within one year after shipment. Check solderability in case of shelf life extension is needed.

#### Cautions:

- a. The corrosive gas reacts on the terminal electrodes of capacitors, and results in the poor solderability. Do not store the capacitors in the ambience of corrosive gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine, ammonia gas etc.)
- b. In corrosive atmosphere, solderability might be degraded, and silver migration might occur to cause low reliability.
- c. Due to the dewing by rapid humidity change, or the photochemical change of the terminal electrode by direct sunlight, the solderability and electrical performance may deteriorate. Do not store capacitors under direct sunlight or dewing condition. To store products on the shelf and avoid exposure to moisture.

#### **Multilayer Ceramic Capacitors**

#### Recommended soldering conditions

The lead-free termination MLCCs are not only to be used on SMT against lead-free solder paste, but also suitable against lead-containing solder paste. If the optimized solder joint is requested, increasing soldering time, temperature and concentration of N2 within oven are recommended.

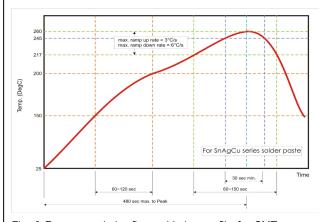


Fig. 6 Recommended reflow soldering profile for SMT process with SnAgCu series solder paste.

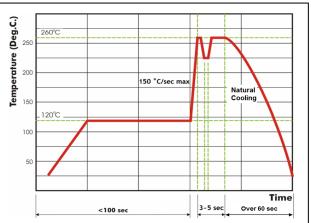


Fig. 7 Recommended wave soldering profile for SMT process with SnAgCu series solder.

